### NXP USA Inc. - MCHLC908QT2PE Datasheet





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#### Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	2MHz
Connectivity	-
Peripherals	LVD, POR, PWM
Number of I/O	5
Program Memory Size	1.5KB (1.5K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mchlc908qt2pe

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MC68HLC908QY4 MC68HLC908QT4 MC68HLC908QY2 MC68HLC908QT2 MC68HLC908QY1 MC68HLC908QT1

**Data Sheet** 

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#### **Revision History**

The following revision history table summarizes changes contained in this document. For your convenience, the page number designators have been linked to the appropriate location.

# **Revision History**

Date	Revision Level	Description		
August, 2003	N/A	Initial release	N/A	
		Figure 2-2. Control, Status, and Data Registers Deleted unimplemented areas from \$FFB0-\$FFBD and \$FFC2-\$FFCF as they are actually available. Also corrected \$FFBF designation from unimplemented to reserved.	26	
		Figure 6-1. COP Block Diagram — Reworked for clarity	57	
October.		6.3.2 STOP Instruction — Added subsection for STOP instruction	58	
2003 1.0	1.0	13.4.2 Active Resets from Internal Sources — Reworked notes for clarity.	115	
		15.3 Monitor Module (MON) — Clarified seventh bullet.	154	
		16.5 DC Electrical Characteristics — Corrected notes 4 and 5.	169	
		16.6 Control Timing — Updated values for $\overline{\text{RST}}$ input pulse width low and $\overline{\text{IRQ}}$ interrupt pulse width low	170	
January, 2.0		Figure 2-2. Control, Status, and Data Registers — Corrected reset state for the FLASH Block Protect Register at address location \$FFBE and the Internal Oscillator Trim Value at \$FFC0.	30	
2004		Figure 2-5. FLASH Block Protect Register (FLBPR) — Restated reset state for clarity.	37	
		Reformatted to meet current documentation standards	Throughout	
July,		Chapter 7 Central Processor Unit (CPU) — In 7.7 Instruction Set Summary: Reworked definitions for STOP instruction Added WAIT instruction	70 71	
2005	0.0	13.8.1 SIM Reset Status Register — Clarified SRSR flag setting.	117	
		14.9.1 TIM Status and Control Register — Added information to TSTOP note.	127	
		17.3 Package Dimensions — Updated package information.	163	



# Chapter 1 General Description

## 1.1 Introduction

The MC68HLC908QY4 is a member of the low-cost, high-performance M68HC08 Family of 8-bit microcontroller units (MCUs). The M68HC08 Family is a Complex Instruction Set Computer (CISC) with a Von Neumann architecture. All MCUs in the family use the enhanced M68HC08 central processor unit (CPU08) and are available with a variety of modules, memory sizes and types, and package types.

Device	FLASH Memory Size	Analog-to-Digital Converter	Pin Count
MC68HLC908QT1	1536 bytes	_	8 pins
MC68HLC908QT2	1536 bytes	4 ch, 8 bit	8 pins
MC68HLC908QT4	4096 bytes	4 ch, 8 bit	8 pins
MC68HLC908QY1	1536 bytes	—	16 pins
MC68HLC908QY2	1536 bytes	4 ch, 8 bit	16 pins
MC68HLC908QY4	4096 bytes	4 ch, 8 bit	16 pins

Table 1-1. Summary of Device Variations

# 1.2 Features

Features include:

- High-performance M68HC08 CPU core
- Fully upward-compatible object code with M68HC05 Family
- Operating voltage range of 2.2 V to 3.6 V
- 2-MHz internal bus operation
- Trimmable internal oscillator
  - 1.0 MHz internal bus operation
  - 8-bit trim capability allows 0.4% accuracy<sup>(1)</sup>
  - ± 25% untrimmed
- Auto wakeup from STOP capability
- Configuration (CONFIG) register for MCU configuration options, including:
  - Low-voltage inhibit (LVI) trip point
- In-system FLASH programming
- FLASH security<sup>(2)</sup>

<sup>1.</sup> The oscillator frequency is guaranteed to  $\pm 5\%$  over temperature and voltage range after trimming.

No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.



#### Memory

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$0005	Data Direction Register B (DDRB)	Read: Write:	DDRB7	DDRB6	DDRB5	DDRB4	DDRB3	DDRB2	DDRB1	DDRB0
	See page 101.	Reset:	0	0	0	0	0	0	0	0
\$0006 ↓ \$000A	Unimplemented									
					_	_	_			
\$000B	Port A Input Pullup Enable Register (PTAPUE)	Read: Write:	OSC2EN	0	PTAPUE5	PTAPUE4	PTAPUE3	PTAPUE2	PTAPUE1	PTAPUE0
See page 99.	Reset:	0	0	0	0	0	0	0	0	
\$000C	Port B Input Pullup Enable Register (PTBPUE)	Read: Write:	PTBPUE7	PTBPUE6	PTBPUE5	PTBPUE4	PTBPUE3	PTBPUE2	PTBPUE1	PTBPUE0
	See page 102.	Reset:	0	0	0	0	0	0	0	0
\$000D ↓ \$0019	Unimplemented									
					<b></b>	<b></b>				
	Keyboard Status and	Read:	0	0	0	0	KEYF	0	IMASKK	MODEK
\$001A	Control Register (KBSCR) See page 83.	Write:						ACKK		
		Reset:	0	0	U	U	U	0	0	0
\$001B	Keyboard Interrupt Enable Register (KBIER)	Write:	0	AWUIE	KBIE5	KBIE4	KBIE3	KBIE2	KBIE1	KBIE0
	See page 84.	Reset:	0	0	0	0	0	0	0	0
\$001C	Unimplemented									
				1					1	
	IRQ Status and Control	Read:	0	0	0	0	IRQF	0	IMASK	MODE
\$001D	Register (INTSCR)	Write:						ACK		
	Oee page 11.	Reset:	0	0	0	0	0	0	0	0
\$001E	Configuration Register 2 (CONFIG2) <sup>(1)</sup>	Read: Write:	IRQPUD	IRQEN	R	OSCOPT1	OSCOPT0	R	R	RSTEN
	See page 53.	Reset:	0	0	0	0	0	0	0	0 <sup>(2)</sup>
			1. One-time 2. RSTEN re	writable regis eset to 0 by a	ter after each power-on res	reset. et (POR) only	ν.			
				= Unimplem	ented	R	= Reserved	U = Unaf	fected	







## 2.6.6 FLASH Block Protect Register

The FLASH block protect register is implemented as a byte within the FLASH memory, and therefore can only be written during a programming sequence of the FLASH memory. The value in this register determines the starting address of the protected range within the FLASH memory.



Write to this register is by a programming sequence to the FLASH memory.

### Figure 2-5. FLASH Block Protect Register (FLBPR)

### BPR[7:0] — FLASH Protection Register Bits [7:0]

These eight bits in FLBPR represent bits [13:6] of a 16-bit memory address. Bits [15:14] are 1s and bits [5:0] are 0s.

The resultant 16-bit address is used for specifying the start address of the FLASH memory for block protection. The FLASH is protected from this start address to the end of FLASH memory, at \$FFFF. With this mechanism, the protect start address can be XX00, XX40, XX80, or XXC0 within the FLASH memory. See Figure 2-6 and Table 2-2.



Figure 2-6. FLASH Block Protect Start Address

Table 2-2. Examples of Protect Start Address

BPR[7:0] Start of Address of Protect Range				
\$00 <b>-</b> \$B8	The entire FLASH memory is protected.			
\$B9 ( <b>1011 1001</b> )	\$EE40 (11 <b>10 1110 01</b> 00 0000)			
\$BA ( <b>1011 1010</b> )	\$EE80 (11 <b>10 1110 10</b> 00 0000)			
\$BB ( <b>1011 1011</b> )	\$EEC0 (11 <b>10 1110 11</b> 00 0000)			
\$BC ( <b>1011 1100</b> )	\$EF00 (11 <b>10 1111 00</b> 00 0000)			
and so on				
\$DE ( <b>1101 1110</b> )	\$F780 (11 <b>11 0111 10</b> 00 0000)			
\$DF ( <b>1101 1111</b> )	\$F7C0 (11 <b>11 0111 11</b> 00 0000)			
\$FE (1111 1110)	\$FF80 (11 <b>11 1111 10</b> 00 0000) FLBPR, OSCTRIM, and vectors are protected			
\$FF	The entire FLASH memory is not protected.			



# Chapter 3 Analog-to-Digital Converter (ADC)

## 3.1 Introduction

This section describes the analog-to-digital converter (ADC). The ADC is an 8-bit, 4-channel analog-todigital converter. The ADC module is only available on the MC68HLC908QY2, MC68HLC908QT2, MC68HLC908QY4, and MC68HLC908QT4.

## 3.2 Features

Features of the ADC module include:

- 4 channels with multiplexed input
- · Linear successive approximation with monotonicity
- 8-bit resolution
- Single or continuous conversion
- Conversion complete flag or conversion complete interrupt
- Selectable ADC clock frequency

## 3.3 Functional Description

Four ADC channels are available for sampling external sources at pins PTA0, PTA1, PTA4, and PTA5. An analog multiplexer allows the single ADC converter to select one of the four ADC channels as an ADC voltage input (ADCVIN). ADCVIN is converted by the successive approximation register-based counters. The ADC resolution is eight bits. When the conversion is completed, ADC puts the result in the ADC data register and sets a flag or generates an interrupt.

Figure 3-2 shows a block diagram of the ADC.

## 3.3.1 ADC Port I/O Pins

PTA0, PTA1, PTA4, and PTA5 are general-purpose I/O pins that are shared with the ADC channels. The channel select bits (ADC status and control register (ADSCR), \$003C), define which ADC channel/port pin will be used as the input signal. The ADC overrides the port I/O logic by forcing that pin as input to the ADC. The remaining ADC channels/port pins are controlled by the port I/O logic and can be used as general-purpose I/O. Writes to the port register or data direction register (DDR) will not have any affect on the port pin that is selected by the ADC. Read of a port pin which is in use by the ADC will return a 0 if the corresponding DDR bit is at 0. If the DDR bit is 1, the value in the port data latch is read.

Input/Output Signals



# 3.6 Input/Output Signals

The ADC module has four channels that are shared with I/O port A.

ADC voltage in (ADCVIN) is the input voltage signal from one of the four ADC channels to the ADC module.

## 3.7 Input/Output Registers

These I/O registers control and monitor ADC operation:

- ADC status and control register (ADSCR)
- ADC data register (ADR)
- ADC clock register (ADICLK)

## 3.7.1 ADC Status and Control Register

The following paragraphs describe the function of the ADC status and control register (ADSCR). When a conversion is in process and the ADSCR is written, the current conversion data should be discarded to prevent an incorrect reading.



Figure 3-3. ADC Status and Control Register (ADSCR)

### COCO — Conversions Complete Bit

In non-interrupt mode (AIEN = 0), COCO is a read-only bit that is set at the end of each conversion. COCO will stay set until cleared by a read of the ADC data register. Reset clears this bit.

In interrupt mode (AIEN = 1), COCO is a read-only bit that is not set at the end of a conversion. It always reads as a 0.

1 = Conversion completed (AIEN = 0)

0 = Conversion not completed (AIEN = 0) or CPU interrupt enabled (AIEN = 1)

NOTE

The write function of the COCO bit is reserved. When writing to the ADSCR register, always have a 0 in the COCO bit position.

### AIEN — ADC Interrupt Enable Bit

When this bit is set, an interrupt is generated at the end of an ADC conversion. The interrupt signal is cleared when ADR is read or ADSCR is written. Reset clears the AIEN bit.

1 = ADC interrupt enabled

0 = ADC interrupt disabled

### ADCO — ADC Continuous Conversion Bit

When set, the ADC will convert samples continuously and update ADR at the end of each conversion. Only one conversion is allowed when this bit is cleared. Reset clears the ADCO bit.

1 = Continuous ADC conversion

0 = One ADC conversion





## 6.3.7 COPRS (COP Rate Select)

The COPRS signal reflects the state of the COP rate select bit (COPRS) in the configuration register 1 (CONFIG1). See Chapter 5 Configuration Register (CONFIG).

# 6.4 COP Control Register

The COP control register (COPCTL) is located at address \$FFFF and overlaps the reset vector. Writing any value to \$FFFF clears the COP counter and starts a new timeout period. Reading location \$FFFF returns the low byte of the reset vector.



Figure 6-2. COP Control Register (COPCTL)

## 6.5 Interrupts

The COP does not generate CPU interrupt requests.

## 6.6 Monitor Mode

The COP is disabled in monitor mode when  $V_{TST}$  is present on the  $\overline{IRQ}$  pin.

## 6.7 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power-consumption standby modes.

## 6.7.1 Wait Mode

The COP continues to operate during wait mode. To prevent a COP reset during wait mode, periodically clear the COP counter.

## 6.7.2 Stop Mode

Stop mode turns off the BUSCLKX4 input to the COP and clears the SIM counter. Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

## 6.8 COP Module During Break Mode

The COP is disabled during a break interrupt with monitor mode when BDCOP bit is set in break auxiliary register (BRKAR).



# Chapter 9 Keyboard Interrupt Module (KBI)

## 9.1 Introduction

The keyboard interrupt module (KBI) provides six independently maskable external interrupts, which are accessible via the PTA0–PTA5 pins.

## 9.2 Features

Features of the keyboard interrupt module include:

- Six keyboard interrupt pins with separate keyboard interrupt enable bits and one keyboard interrupt mask
- Software configurable pullup device if input pin is configured as input port bit
- Programmable edge-only or edge and level interrupt sensitivity
- Exit from low-power modes

# 9.3 Functional Description

The keyboard interrupt module controls the enabling/disabling of interrupt functions on the six port A pins. These six pins can be enabled/disabled independently of each other.

## 9.3.1 Keyboard Operation

Writing to the KBIE0–KBIE5 bits in the keyboard interrupt enable register (KBIER) independently enables or disables each port A pin as a keyboard interrupt pin. Enabling a keyboard interrupt pin in port A also enables its internal pullup device irrespective of PTAPUEx bits in the port A input pullup enable register (see 12.2.3 Port A Input Pullup Enable Register). A logic 0 applied to an enabled keyboard interrupt pin latches a keyboard interrupt request.

A keyboard interrupt is latched when one or more keyboard interrupt inputs goes low after all were high. The MODEK bit in the keyboard status and control register controls the triggering mode of the keyboard interrupt.

- If the keyboard interrupt is edge-sensitive only, a falling edge on a keyboard interrupt input does not latch an interrupt request if another keyboard pin is already low. To prevent losing an interrupt request on one input because another input is still low, software can disable the latter input while it is low.
- If the keyboard interrupt is falling edge and low-level sensitive, an interrupt request is present as long as any keyboard interrupt input is low.



#### **Functional Description**



#### Figure 9-2. Keyboard Interrupt Block Diagram

If the MODEK bit is set, the keyboard interrupt inputs are both falling edge and low-level sensitive, and both of the following actions must occur to clear a keyboard interrupt request:

- Vector fetch or software clear A vector fetch generates an interrupt acknowledge signal to clear the interrupt request. Software may generate the interrupt acknowledge signal by writing a 1 to the ACKK bit in the keyboard status and control register (KBSCR). The ACKK bit is useful in applications that poll the keyboard interrupt inputs and require software to clear the keyboard interrupt request. Writing to the ACKK bit prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACKK does not affect subsequent transitions on the keyboard interrupt inputs. A falling edge that occurs after writing to the ACKK bit latches another interrupt request. If the keyboard interrupt mask bit, IMASKK, is clear, the central processor unit (CPU) loads the program counter with the vector address at locations \$FFE0 and \$FFE1.
- Return of all enabled keyboard interrupt inputs to logic 1 As long as any enabled keyboard interrupt pin is at logic 0, the keyboard interrupt remains set. The auto wakeup interrupt input, AWUIREQ, will be cleared only by writing to ACKK bit in KBSCR or reset.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to logic 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt input stays at logic 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.



# Chapter 13 System Integration Module (SIM)

## **13.1 Introduction**

This section describes the system integration module (SIM), which supports up to 24 external and/or internal interrupts. Together with the central processor unit (CPU), the SIM controls all microcontroller unit (MCU) activities. A block diagram of the SIM is shown in Figure 13-1. The SIM is a system state controller that coordinates CPU and exception timing.

The SIM is responsible for:

- · Bus clock generation and control for CPU and peripherals
  - Stop/wait/reset/break entry and recovery
  - Internal clock control
- Master reset control, including power-on reset (POR) and computer operating properly (COP) timeout
- Interrupt control:
  - Acknowledge timing
  - Arbitration control timing
  - Vector address generation
- CPU enable/disable timing

# 13.2 RST and IRQ Pins Initialization

RST and IRQ pins come out of reset as PTA3 and PTA2 respectively. RST and IRQ functions can be activated by programing CONFIG2 accordingly. Refer to Chapter 5 Configuration Register (CONFIG).

Signal Name	Description
BUSCLKX4	Buffered clock from the internal, RC or XTAL oscillator circuit.
BUSCLKX2	The BUSCLKX4 frequency divided by two. This signal is again divided by two in the SIM to generate the internal bus clocks (bus clock = BUSCLKX4 $\div$ 4).
Address bus	Internal address bus
Data bus	Internal data bus
PORRST	Signal from the power-on reset module to the SIM
IRST	Internal reset signal
R/W	Read/write signal

Table 13-1. Signal Name Conventions



**Exception Control** 



Figure 13-10. Interrupt Recognition Example



#### System Integration Module (SIM)

state by forcing it to the SWI vector location. Refer to the break interrupt subsection of each module to see how each module is affected by the break state.

## 13.6.5 Status Flag Protection in Break Mode

The SIM controls whether status flags contained in other modules can be cleared during break mode. The user can select whether flags are protected from being cleared by properly initializing the break clear flag enable bit (BCFE) in the break flag control register (BFCR).

Protecting flags in break mode ensures that set flags will not be cleared while in break mode. This protection allows registers to be freely read and written during break mode without losing status flag information.

Setting the BCFE bit enables the clearing mechanisms. Once cleared in break mode, a flag remains cleared even when break mode is exited. Status flags with a two-step clearing mechanism — for example, a read of one register followed by the read or write of another — are protected, even when the first step is accomplished prior to entering break mode. Upon leaving break mode, execution of the second step will clear the flag as normal.

## 13.7 Low-Power Modes

Executing the WAIT or STOP instruction puts the MCU in a low power-consumption mode for standby situations. The SIM holds the CPU in a non-clocked state. The operation of each of these modes is described below. Both STOP and WAIT clear the interrupt mask (I) in the condition code register, allowing interrupts to occur.

### 13.7.1 Wait Mode

In wait mode, the CPU clocks are inactive while the peripheral clocks continue to run. Figure 13-14 shows the timing for wait mode entry.

ADDRESS BUS	WAIT ADDR		DR + 1	SAME	X	SAME	X
DATA BUS	PREVIOUS	S DATA		CODE	SAME		SAME
R/W							

NOTE: Previous data can be operand data or the WAIT opcode, depending on the last instruction.

#### Figure 13-14. Wait Mode Entry Timing

A module that is active during wait mode can wake up the CPU with an interrupt if the interrupt is enabled. Stacking for the interrupt begins one cycle after the WAIT instruction during which the interrupt occurred. In wait mode, the CPU clocks are inactive. Refer to the wait mode subsection of each module to see if the module is active or inactive in wait mode. Some modules can be programmed to be active in wait mode.

Wait mode can also be exited by a reset (or break in emulation mode). A break interrupt during wait mode sets the SIM break stop/wait bit, SBSW, in the break status register (BSR). If the COP disable bit, COPD, in the configuration register is 0, then the computer operating properly module (COP) is enabled and remains active in wait mode.



#### System Integration Module (SIM)

The SIM counter is held in reset from the execution of the STOP instruction until the beginning of stop recovery. It is then used to time the recovery period. Figure 13-17 shows stop mode entry timing and Figure 13-18 shows the stop mode recovery time from interrupt or break

**NOTE** To minimize stop current, all pins configured as inputs should be driven to



Figure 13-18. Stop Mode Recovery from Interrupt

## 13.8 SIM Registers

The SIM has three memory mapped registers. Table 13-4 shows the mapping of these registers.

Table 13-4.	. SIM	Registers
-------------	-------	-----------

Address	Register	Access Mode
\$FE00	BSR	User
\$FE01	SRSR	User
\$FE03	BFCR	User







Figure 15-10. Monitor Mode Circuit (External Clock, with High Voltage)



Figure 15-11. Monitor Mode Circuit (External Clock, No High Voltage)



**Electrical Specifications** 

# 16.3 Functional Operating Range

Characteristic	Symbol	Value	Unit	Temp Code
Operating temperature range ( $T_L$ to $T_H$ )	Τ <sub>Α</sub>	-40 to 85 0 to 70	°C	ပ
Operating voltage range <sup>(1)</sup> (V <sub>DDMIN</sub> to V <sub>DDMAX</sub> ) -40 to 85°C 0 to 70°C	V <sub>DD</sub>	2.4 to 3.6 2.2 to 3.6	V	ပ

1.  $V_{DD}$  must be above  $V_{TRIPR}$  upon power on.

# **16.4 Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal resistance 8-pin PDIP 8-pin SOIC 8-pin DFN 16-pin PDIP 16-pin SOIC 16-pin TSSOP	θ <sub>JA</sub>	105 142 173 76 90 133	°C/W
I/O pin power dissipation	P <sub>I/O</sub>	User determined	W
Power dissipation <sup>(1)</sup>	P <sub>D</sub>	$P_D = (I_{DD} \times V_{DD})$ + $P_{I/O} = K/(T_J + 273^{\circ}C)$	W
Constant <sup>(2)</sup>	К	$P_{D} x (T_{A} + 273^{\circ}C) + P_{D}^{2} x \theta_{JA}$	W/°C
Average junction temperature	Т <sub>Ј</sub>	$T_A + (P_D \times \theta_{JA})$	°C
Maximum junction temperature	Т <sub>ЈМ</sub>	150	°C

1. Power dissipation is a function of temperature.

2. K constant unique to the device. K can be determined for a known  $T_A$  and measured  $P_D$ . With this value of K,  $P_D$  and  $T_J$  can be determined for any value of  $T_A$ .





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